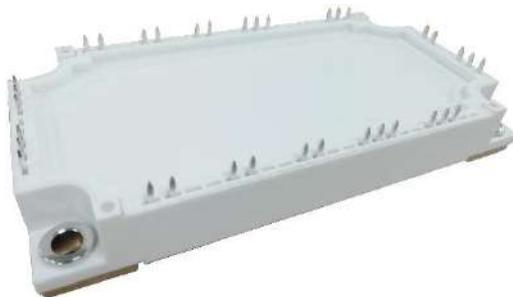


HCG50FP120M3D1 1200V/50A PIM IGBT Module

Description

The HCG50FP120M3D1 offer lower losses and higher energy for application such as motor drive, inverter and other soft switching applications.



Features

- 1200V 50A, VCE (sat) (typ.) = 2.10V
- Lower losses and higher energy
- Excellent short circuit ruggedness
- PIM module

Applications

- Inverter
- Power supply
- Motion/servo control

Circuit diagram

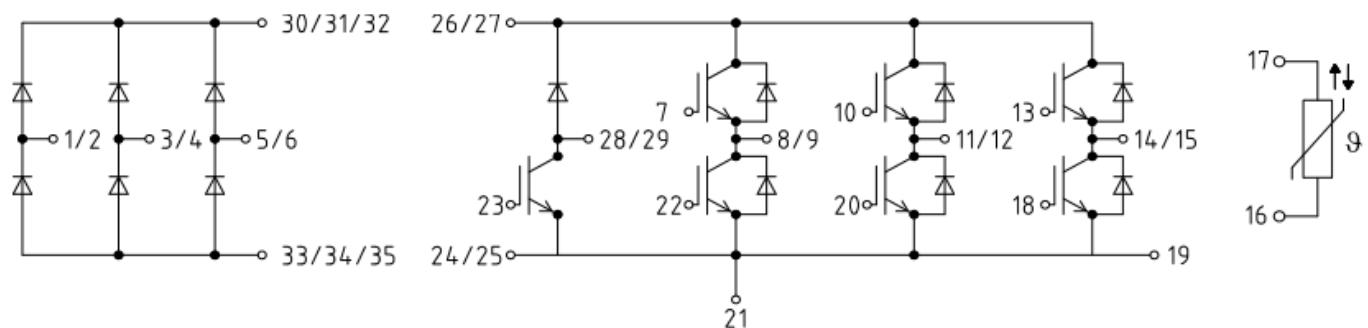


Figure 1. Out drawing & circuit diagram for HCG50FP120M3D1

HCG50FP120M3D1

1200V/50A PIM IGBT Module

Pin Configuration and Marking Information

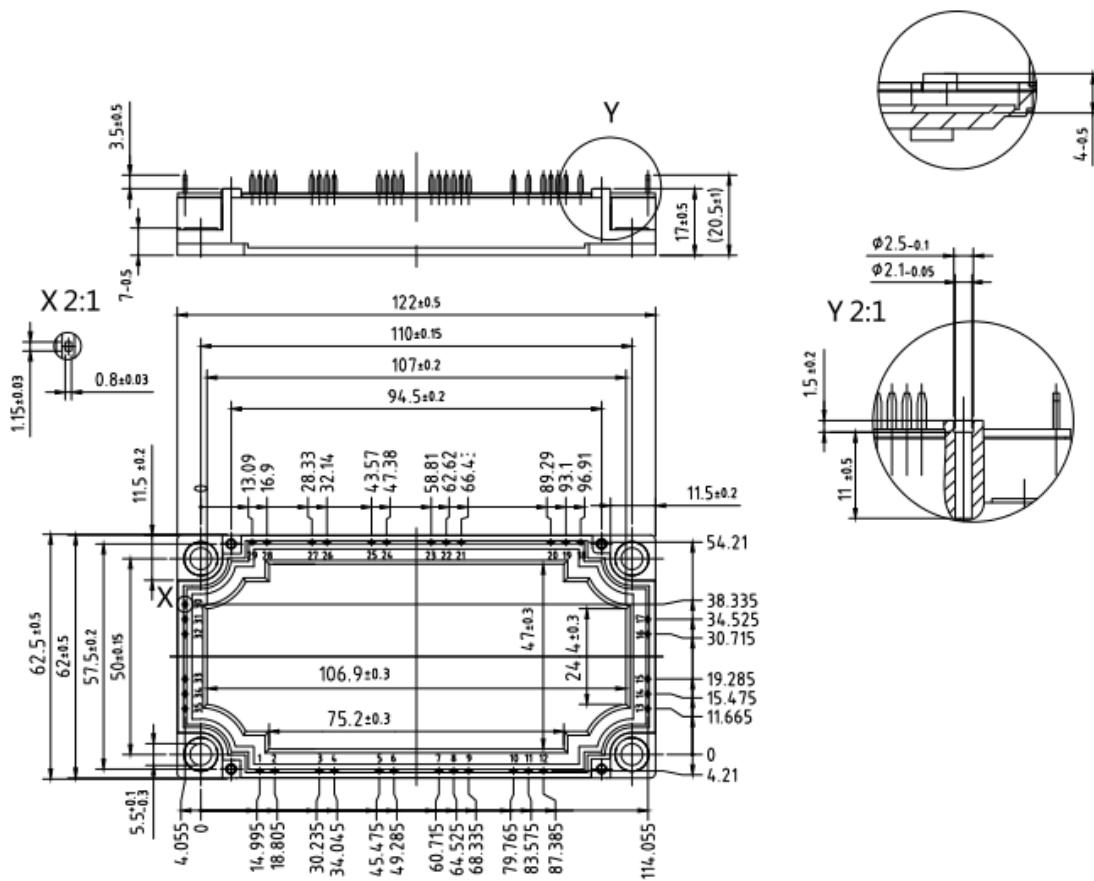


Figure 2. Pin configuration

Module

| Parameter | Conditions | Value | Unit |
|--|--|------------|------|
| Isolation Voltage | RMS, f=50Hz, t=1min | 2.5 | KV |
| Material of module baseplate | - | Cu | - |
| Creepage distance | terminal to heatsink terminal to terminal | 17 3.81 | mm |
| Clearance | terminal to heatsink terminal to terminal | 17 3.81 | mm |
| CTI | - | >200 | - |
| Module lead resistance, terminals – chip | T _C =25°C | 0.8 | mΩ |
| Mounting torque for module mounting | M5 | 3 to 6 | Nm |
| Weight | - | 300 | g |

HCG50FP120M3D1**1200V/50A PIM IGBT Module****Maximum Ratings** (IGBT, $T_j=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Conditions | Ratings | Unit |
|-----------|---------------------------------|--------------------------|------------------|------------------|
| V_{CES} | Collector-Emitter Voltage | G-E Short | 1200 | V |
| V_{RRM} | Peak Repetitive Revers Voltage | - | 1200 | V |
| V_{GES} | Gate-Emitter Voltage | C-E Short | $\pm 30\text{V}$ | V |
| I_C | DC Continuous Collector Current | $T_C=100^\circ\text{C}$ | 50 | A |
| I_{CM} | Pulse Collector Current | $t_p=1\text{ms}$, Note1 | 100 | A |
| P_C | Maximum Power Dissipation | | 365 | W |
| T_j | junction temperature | - | -40 to 150 | $^\circ\text{C}$ |
| T_{stg} | Storage temperature | - | -40 to 125 | $^\circ\text{C}$ |

Note1: Pulse width limited by maximum junction temperature

Maximum Ratings (Freewheeling diode, $T_j=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Conditions | Ratings | Unit |
|-----------|---------------------------------|--------------------------|------------|------------------|
| V_{RRM} | Peak Repetitive Revers Voltage | - | 1200 | V |
| I_F | Diode forward Current | - | 50 | A |
| I_{FRM} | Repetitive peak forward Current | $t_p=1\text{ms}$, Note1 | 100 | A |
| T_j | junction temperature | - | -40 to 150 | $^\circ\text{C}$ |
| T_{stg} | Storage temperature | - | -40 to 125 | $^\circ\text{C}$ |

Note1: Pulse width limited by maximum junction temperature

Maximum Ratings (IGBT, Brake-chopper, $T_j=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Conditions | Ratings | Unit |
|-----------|---------------------------------|--------------------------|------------------|------------------|
| V_{CES} | Collector-Emitter Voltage | G-E Short | 1200 | V |
| V_{RRM} | Peak Repetitive Revers Voltage | - | 1200 | V |
| V_{GES} | Gate-Emitter Voltage | C-E Short | $\pm 30\text{V}$ | V |
| I_C | DC Continuous Collector Current | $T_C=100^\circ\text{C}$ | 25 | A |
| I_{CM} | Pulse Collector Current | $t_p=1\text{ms}$, Note1 | 50 | A |
| P_C | Maximum Power Dissipation | | 280 | W |
| T_j | junction temperature | - | -40 to 150 | $^\circ\text{C}$ |
| T_{stg} | Storage temperature | - | -40 to 125 | $^\circ\text{C}$ |

Note1: Pulse width limited by maximum junction temperature

Maximum Ratings (diode, Brake-chopper, $T_j=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Conditions | Ratings | Unit |
|-----------|---------------------------------|--------------------------|------------|------------------|
| V_{RRM} | Peak Repetitive Revers Voltage | - | 1200 | V |
| I_F | Diode forward Current | - | 25 | A |
| I_{FRM} | Repetitive peak forward Current | $t_p=1\text{ms}$, Note1 | 50 | A |
| T_j | junction temperature | - | -40 to 150 | $^\circ\text{C}$ |
| T_{stg} | Storage temperature | - | -40 to 125 | $^\circ\text{C}$ |

Note1: Pulse width limited by maximum junction temperature

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1200V/50A PIM IGBT Module

NTC characteristics

| Symbol | Parameter | Condition | Value | | | Unit |
|---------------------|-------------------|--|-------|------|------|------|
| | | | Min. | Typ. | Max. | |
| R ₂₅ | Resistance | T _C =25°C | - | 5 | - | kΩ |
| R/R | Deviation of R100 | T _C =100°C, R ₁₀₀ =493Ω | -5 | - | 5 | % |
| P ₂₅ | Power dissipation | T _C =25°C | - | - | 50 | mW |
| B _{25/50} | B-value | R ₂ = R ₂₅ exp [B _{25/50} (1/T ₂ - 1/(298,15 K))] | - | 3375 | - | K |
| B _{25/80} | B-value | R ₂ = R ₂₅ exp [B _{25/80} (1/T ₂ - 1/(298,15 K))] | - | 3410 | - | K |
| B _{25/100} | B-value | R ₂ = R ₂₅ exp [B _{25/100} (1/T ₂ - 1/(298,15 K))] | - | 3433 | - | K |

IGBT Electrical characteristics (T_j=25°C unless otherwise specified, chip)

| Symbol | Item | Condition | Value | | | Unit | |
|--------------------------------|---|--|-----------------------|------|------|-------|------|
| | | | Min. | Typ. | Max | | |
| V _{CE(sat)} (Chip) | Collector-Emitter Saturation Voltage | I _C =50A | T _j =25°C | - | 2.1 | 2.3 | V |
| | | V _{GE} =15V | T _j =125°C | - | 2.5 | - | V |
| V _{GE(th)} | Gate-Emitter threshold Voltage | I _C =1mA, V _{CE} =V _{GE} | | 4.5 | - | 5.7 | V |
| Q _G | Gate charge | V _{GE} =-15V to +15V | | - | 430 | - | nC |
| R _{Gint} | Internal gate resistor | f=1M, V _{pp} =1V | T _j =25°C | - | 2.2 | - | Ω |
| C _{ies} | Input Capacitance | V _{CE} =25V, V _{GE} =0V f=1MHz | T _j =25°C | - | 3.8 | - | nF |
| C _{oes} | Output Capacitance | | | - | 0.51 | - | nF |
| C _{res} | Reverse transfer Capacitance | | | - | 0.33 | - | nF |
| I _{CES} | Collector- Emitter Cut off Current | V _{CE} =1200V, V _{GE} =0V | T _j =25°C | - | - | 1 | mA |
| I _{GES} | Gate-Emitter Leakage Current | V _{GE} =30V, V _{CE} =0V | T _j =25°C | - | - | 100 | nA |
| t _{d(on)} | Turn-on delay time | V _{CC} =600V I _C = 50A V _{GE} =+15V/-15V R _G =10Ω Inductive load | T _j =25°C | - | 20 | - | ns |
| t _r | Rise time | | T _j =25°C | - | 35 | - | ns |
| t _{d(off)} | Turn-off delay time | | T _j =25°C | - | 250 | - | ns |
| t _f | Fall time | | T _j =25°C | - | 330 | - | ns |
| E _{on} | Turn-on power dissipation | | T _j =25°C | - | 3.9 | - | mJ |
| E _{off} | Turn-off power dissipation | | T _j =25°C | - | 2.2 | - | mJ |
| R _{th(j-c)} | Thermal Resistance, Junction to Case (IGBT) | | | - | - | 0.343 | °C/W |

HCG50FP120M3D1

1200V/50A PIM IGBT Module

Freewheeling Diode Electrical characteristics ($T_j=25^\circ\text{C}$ unless otherwise specified, chip)

| Symbol | Item | Condition | Value | | | Unit |
|---------------|--|--|---------------------------|------|-------|---------------------------|
| | | | Min. | Typ. | Max | |
| V_F | Diode Forward Voltage | $I_F = 50\text{A}, V_{GE} = 0\text{V}$ | $T_j = 25^\circ\text{C}$ | - | 1.90 | 2.20 |
| | | | $T_j = 125^\circ\text{C}$ | - | 1.90 | - |
| t_{rr} | Reverse recovery time | (Switch side) $V_{rr} = 600\text{V}, I_F = 50\text{A}$ $dI/dt = 890\text{A}/\mu\text{s}$ | $T_j = 25^\circ\text{C}$ | - | 110 | - |
| I_{rr} | Peak reverse recovery Current | | $T_j = 25^\circ\text{C}$ | - | 55 | - |
| Q_{rr} | Recovered charge | | $T_j = 25^\circ\text{C}$ | - | 3.00 | - |
| E_{rr} | Reverse recovered energy | | $T_j = 25^\circ\text{C}$ | - | 0.80 | - |
| $R_{th(j-c)}$ | Thermal Resistance, Junction to Case (Diode) | | - | | 0.652 | $^\circ\text{C}/\text{W}$ |

IGBT, Brake - chopper Electrical characteristics ($T_j=25^\circ\text{C}$ unless otherwise specified, chip)

| Symbol | Item | Condition | Value | | | Unit |
|--------------------------------|---|--|---------------------------|------|------|---------------------------|
| | | | Min. | Typ. | Max | |
| $V_{CE(\text{sat})}$ (Chip) | Collector-Emitter Saturation Voltage | $I_C = 25\text{A}$ | $T_j = 25^\circ\text{C}$ | - | 2.1 | 2.3 |
| | | $V_{GE} = 15\text{V}$ | $T_j = 125^\circ\text{C}$ | - | 2.5 | - |
| $V_{GE(\text{th})}$ | Gate-Emitter threshold Voltage | $I_C = 1\text{mA}, V_{CE} = V_{GE}$ | 4.5 | - | 5.7 | V |
| Q_G | Gate charge | $V_{GE} = -15\text{V}$ to $+15\text{V}$ | - | 140 | - | nC |
| R_{Gint} | Internal gate resistor | $f = 1\text{MHz}, V_{pp} = 1\text{V}$ | $T_j = 25^\circ\text{C}$ | - | 8.0 | - |
| C_{ies} | Input Capacitance | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$ $f = 1\text{MHz}$ | $T_j = 25^\circ\text{C}$ | - | 1.08 | - |
| C_{oes} | Output Capacitance | | $T_j = 25^\circ\text{C}$ | - | 0.17 | - |
| C_{res} | Reverse transfer Capacitance | | $T_j = 25^\circ\text{C}$ | - | 0.12 | - |
| I_{CES} | Collector- Emitter Cut off Current | $V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}$ | $T_j = 25^\circ\text{C}$ | - | - | 1 mA |
| I_{GES} | Gate-Emitter Leakage Current | $V_{GE} = 30\text{V}, V_{CE} = 0\text{V}$ | $T_j = 25^\circ\text{C}$ | - | - | 100 nA |
| $t_{d(on)}$ | Turn-on delay time | $V_{CC} = 600\text{V}$ $I_C = 25\text{A}$ $V_{GE} = +15\text{V}/-15\text{V}$ $R_G = 13\text{m}\Omega$ Inductive load | $T_j = 25^\circ\text{C}$ | - | 20 | - |
| t_r | Rise time | | $T_j = 25^\circ\text{C}$ | - | 40 | - |
| $t_{d(off)}$ | Turn-off delay time | | $T_j = 25^\circ\text{C}$ | - | 280 | - |
| t_f | Fall time | | $T_j = 25^\circ\text{C}$ | - | 210 | - |
| E_{on} | Turn-on power dissipation | | $T_j = 25^\circ\text{C}$ | - | 1.8 | - |
| E_{off} | Turn-off power dissipation | | $T_j = 25^\circ\text{C}$ | - | 1.7 | - |
| $R_{th(j-c)}$ | Thermal Resistance, Junction to Case (IGBT) | | - | - | 0.45 | $^\circ\text{C}/\text{W}$ |

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1200V/50A PIM IGBT Module

Diode , Brake-chopper Electrical characteristics ($T_j=25^\circ\text{C}$ unless otherwise specified, chip)

| Symbol | Item | Condition | Value | | | Unit |
|---------------|--|---|---------------------------|------|------|------|
| | | | Min. | Typ. | Max | |
| V_F | Diode Forward Voltage | $I_F = 25\text{A}, V_{GE} = 0\text{V}$ | $T_j = 25^\circ\text{C}$ | - | 1.90 | 2.2 |
| | | | $T_j = 125^\circ\text{C}$ | - | 1.9 | - |
| t_{rr} | Reverse recovery time | (Switch side) $V_{rr} = 600\text{V}, I_F = 25\text{A}$ $di/dt = 1200\text{A}/\mu\text{s}$ | $T_j = 25^\circ\text{C}$ | - | 120 | - |
| I_{rr} | Peak reverse recovery Current | | $T_j = 25^\circ\text{C}$ | - | 17 | - |
| Q_{rr} | Recovered charge | | $T_j = 25^\circ\text{C}$ | - | 1.3 | - |
| E_{rr} | Reverse recovered energy | | $T_j = 25^\circ\text{C}$ | - | 0.4 | - |
| $R_{th(j-c)}$ | Thermal Resistance, Junction to Case (Diode) | | - | | 1.31 | °C/W |

Maximum Ratings (Rectifier diode, $T_j=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Conditions | Ratings | Unit |
|-------------|---|--------------------------|------------|----------------------|
| V_{RRM} | Peak Repetitive Revers Voltage | $T_J = 25^\circ\text{C}$ | 1800 | V |
| I_{FRMSM} | Maximum RMS forward current per chip | $T_C = 80^\circ\text{C}$ | 50 | A |
| I_{RMSM} | Maximum RMS current at rectifier output | $T_C = 80^\circ\text{C}$ | 100 | A |
| I_{FSM} | Surge Current @ $t_p=10\text{ ms}$ | $T_J = 25^\circ\text{C}$ | 420 | A |
| I^2t | I^2t - value | $T_J = 25^\circ\text{C}$ | 880 | A^2s |
| T_j | junction temperature | - | -40 to 150 | °C |
| T_{stg} | Storage temperature | - | -40 to 125 | °C |

Note1: Pulse width limited by maximum junction temperature

Rectifier Diode Electrical characteristics ($T_j=25^\circ\text{C}$ unless otherwise specified, chip)

| Symbol | Item | Condition | Value | | | Unit |
|-----------------|--|--------------------|---------------------------|------|------|------|
| | | | Min. | Typ. | Max | |
| V_F | Diode Forward Voltage | $I_F = 50\text{A}$ | $T_J = 25^\circ\text{C}$ | | 1.05 | V |
| | | | $T_J = 125^\circ\text{C}$ | | 0.85 | |
| I_R | Reverse current | | $T_J = 125^\circ\text{C}$ | | 1.0 | mA |
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case (Diode) | | | | 0.85 | °C/W |

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1200V/50A PIM IGBT Module

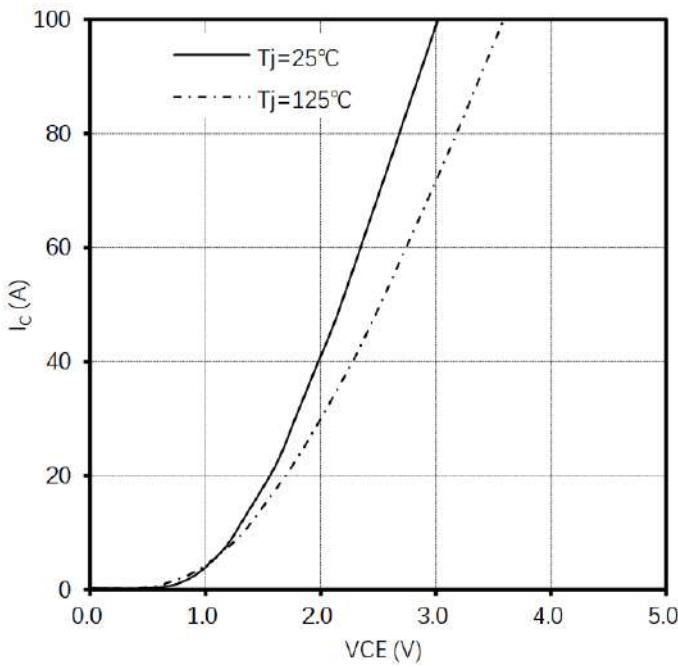


Fig 1. output characteristic IGBT,
 $I_c=f(V_{CE})$, $V_{GE}=15V$

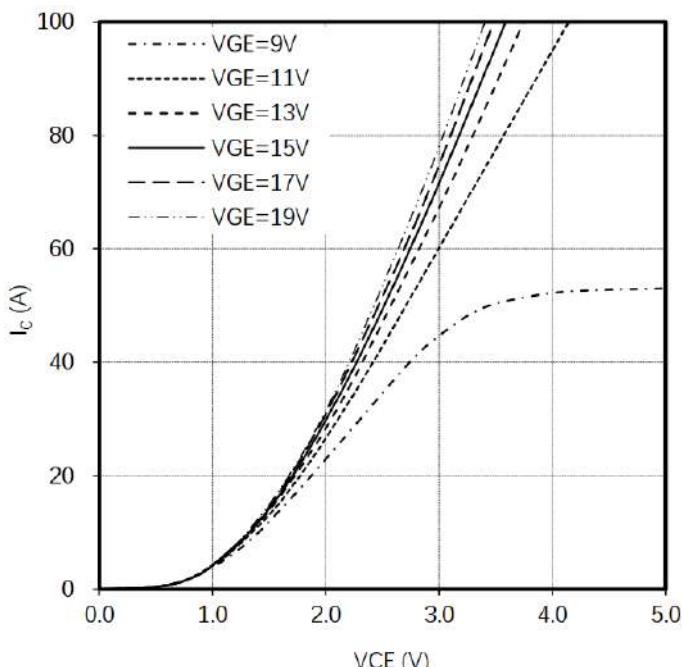


Fig 2. output characteristic IGBT,
 $I_c=f(V_{CE})$, $T_j=125^\circ C$

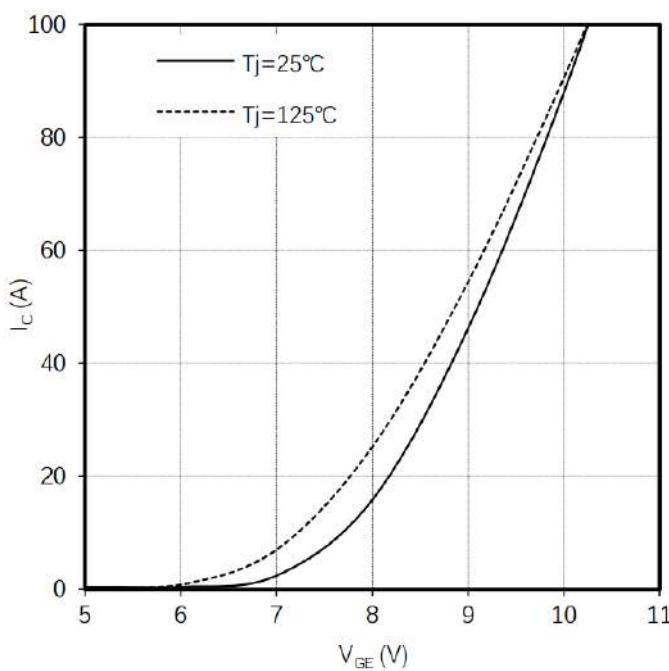


Fig 3. transfer characteristic IGBT,
 $I_c=f(V_{GE})$, $V_{CE}=20V$

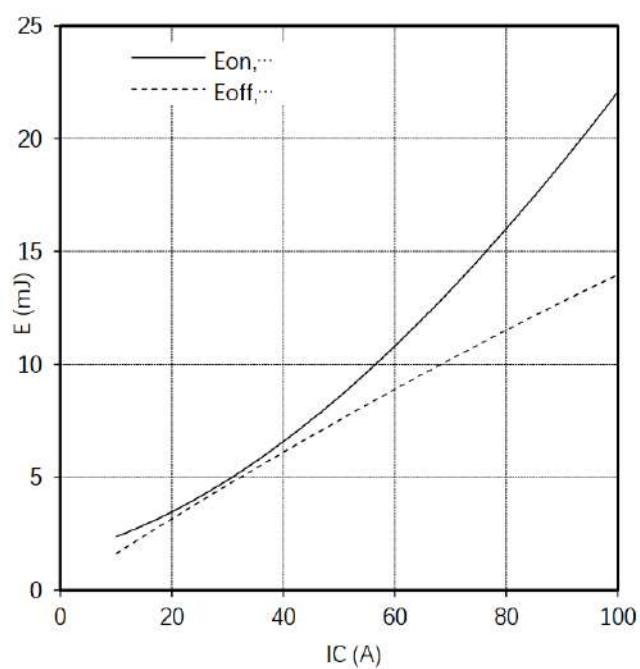


Fig 4. switching losses IGBT,
 $E_{on}=f(I_c)$, $E_{off}=f(I_c)$,
 $V_{GE}=\pm 15V$, $R_{Gon}=18\Omega$, $R_{Goff}=18\Omega$, $V_{CE}=600V$

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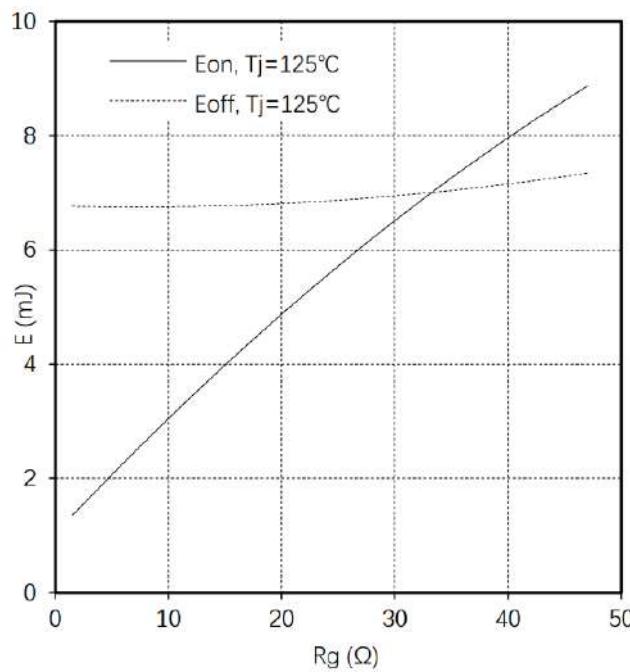


Fig 5. switching losses IGBT, $E_{on}=f(R_g)$, $E_{off}=f(R_g)$,
 $V_{GE}=\pm 15V$, $I_c=50A$, $V_{CE}=600V$

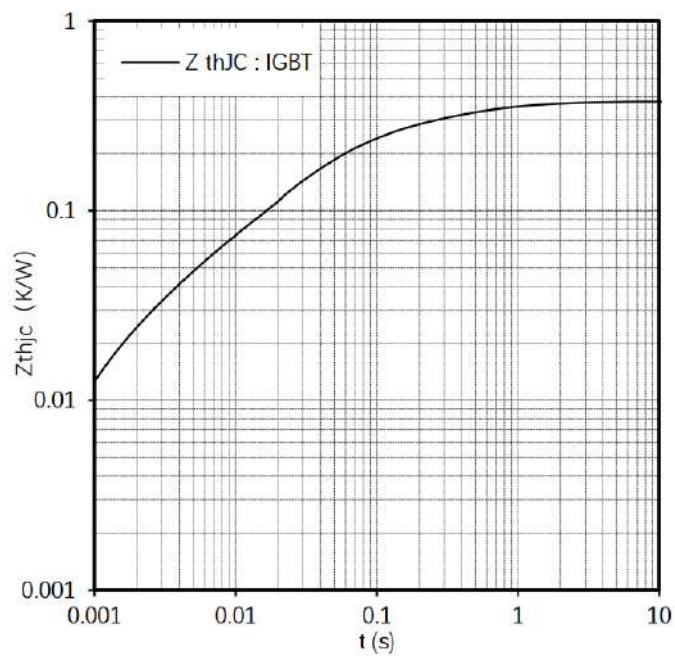


Fig 6. transient thermal impedance IGBT ,
 $Z_{thjc}=f(t)$

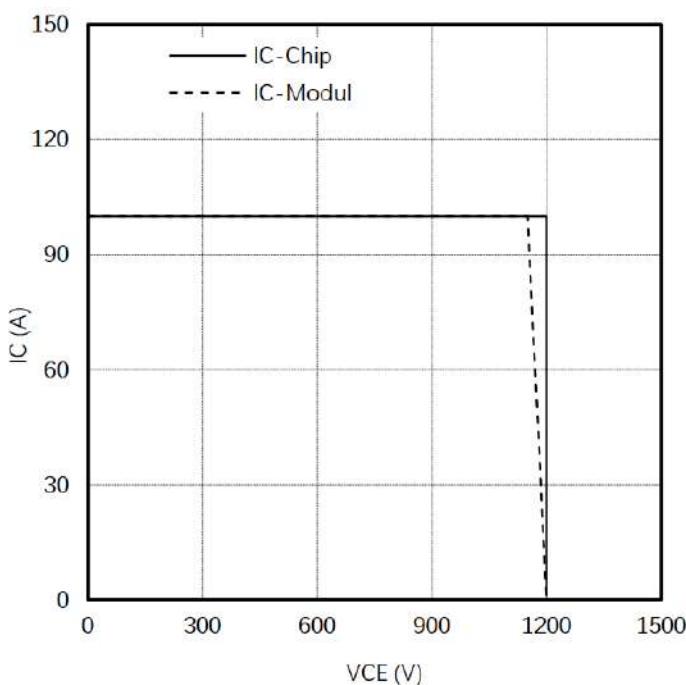


Fig 7. reverse bias safe operating area IGBT,
 $I_c=f(V_{CE})$, $V_{GE}=\pm 15V$, $R_{Goff}=18\Omega$, $T_{vj}=125^\circ C$

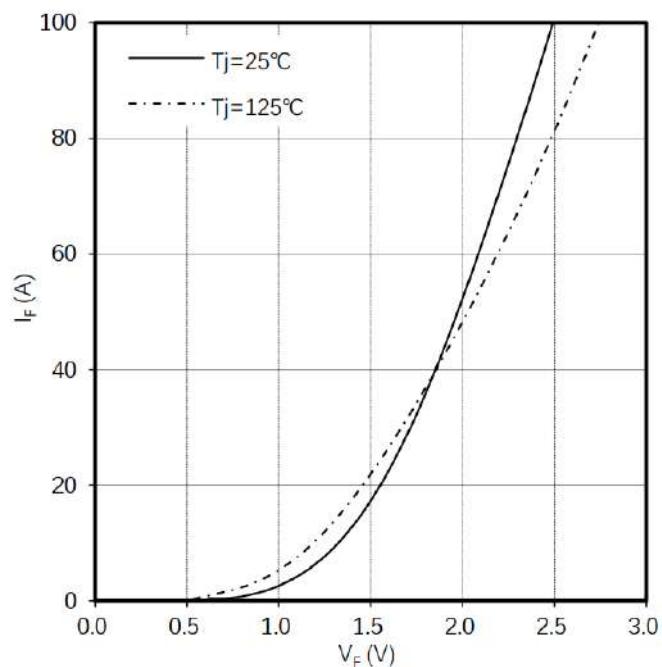


Fig 8. forward characteristic of Diode ,
 $I_F=f(V_F)$

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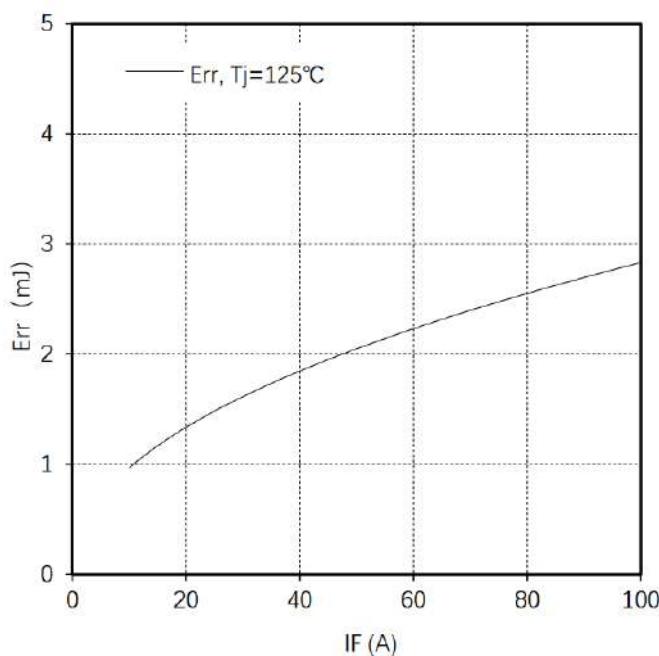


Fig9. switching losses Diode,
 $E_{rr}=f(I_F), R_{Gon}=18\Omega, V_{CE}=600V$

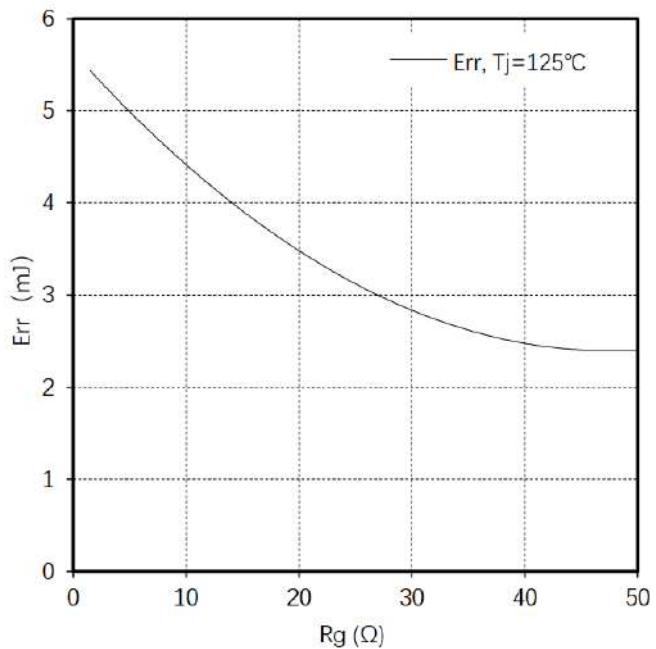


Fig 10. switching losses Diode,
 $E_{rr}=f(R_g), I_F=50A, V_{CE}=600V$

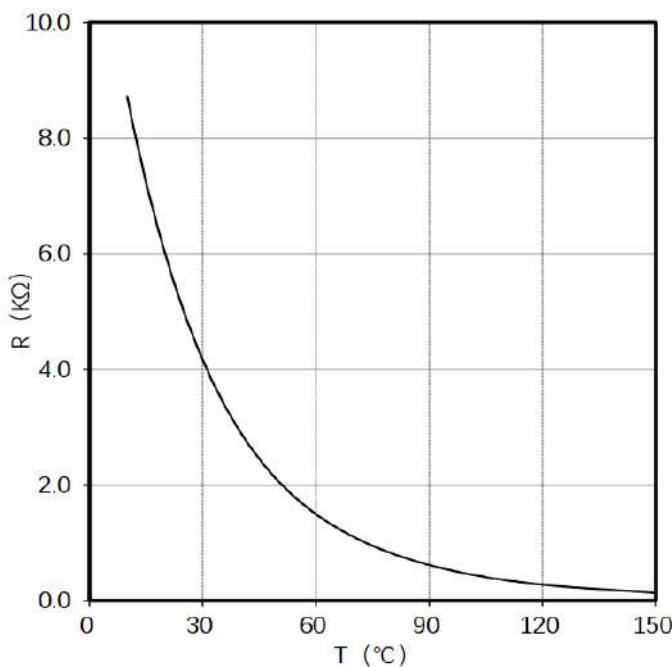


Fig11.NTC-Thermistor-temperature
characteristic(typical)

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1200V/50A PIM IGBT Module

IMPORTANT NOTICE:

This product data sheet describes the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively under the terms and conditions of the supply agreement. There will be no guarantee or of any kind for the product and its characteristics.

The data contained in this document is exclusively intended for technically trained staff. You and your technical departments will have to evaluate the product's suitability for the intended application and the completeness of the product data concerning such application.

Due to technical requirements, our product may contain dangerous substances. For information on the types in question, please contact the sales staff responsible for you.

Changes to this product data sheet are reserved.

Please contact the sales staff (Email:sales@hiitio.com) for further information on the product, technology, delivery terms, conditions and prices.

Revision History

| Document Version | Description of Changes |
|------------------|------------------------|
| RevX.0.1 | Released |
| | |
| | |

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